



IPC-A-610H
"Acceptability of Electronic Assemblies"
Training and Certification Program

# MODULE OBJECTIVES





- Introduce students to the training program
- Familiarize participants with facility policies and procedures
- Explain evaluation criteria



# MODULE OVERVIEW





- Facility Policy and Procedures
- Course Overview
- Exam Information



# FACILITY POLICY AND PROCEDURES



**Starting/Ending Time** 

**Breaks/Break Rooms** 

Messages/Cellphones

**Food and Drink** 

**Smoking** 

**Restrooms** 

**Emergency Exits** 



### **COURSE OVERVIEW**

In	tr	റപ	uction
	L	VЧ	uction

**Module 1:** General, Applicable Documents and Handling – Mandatory for CIS

**Module 2:** Soldering and High Voltage

Module 3: Component Damage & Printed Boards and Assemblies

**Module 4:** Terminal Connections (Requires M2)

Module 5: Through-Hole Technology & Jumper Wires (Requires M2 & M3)

Module 6: Surface Mount Assemblies & Jumper Wires (Requires M2 & M3)

**Module 7:** Hardware



## **EVALUATIONS AND EXPECTATIONS**

#### **CIS Requirements**

- Multiple choice examinations, one for each module
  - Open book examinations
  - 70% minimum acceptable score on each exam



#### **CIT Requirements**

- Multiple choice examinations on the last day of class
  - Open book examination
  - Closed book examination
  - 80% minimum acceptable score on each exam



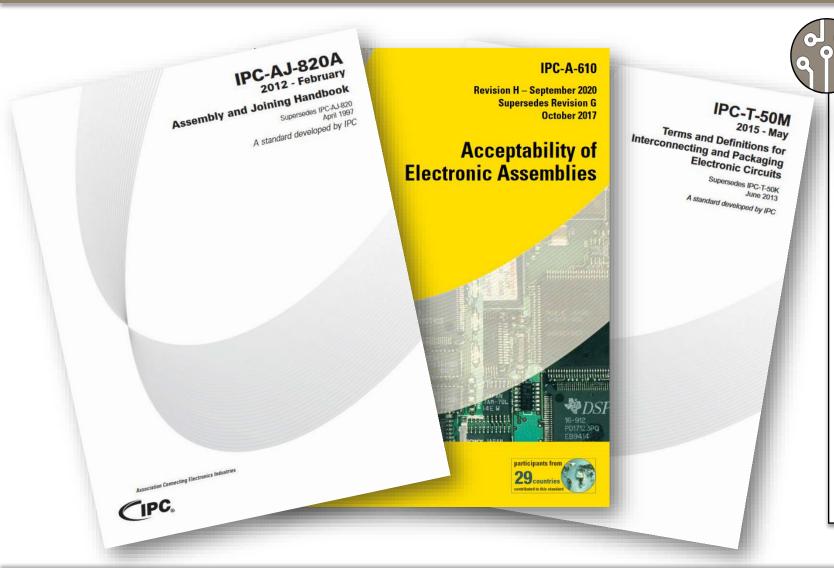
#### **CSE Requirements**

- Multiple choice examinations on the last day of class
  - Open book examination (standard specific)
  - Closed book examination (general knowledge)
  - 80% minimum acceptable score on each exam



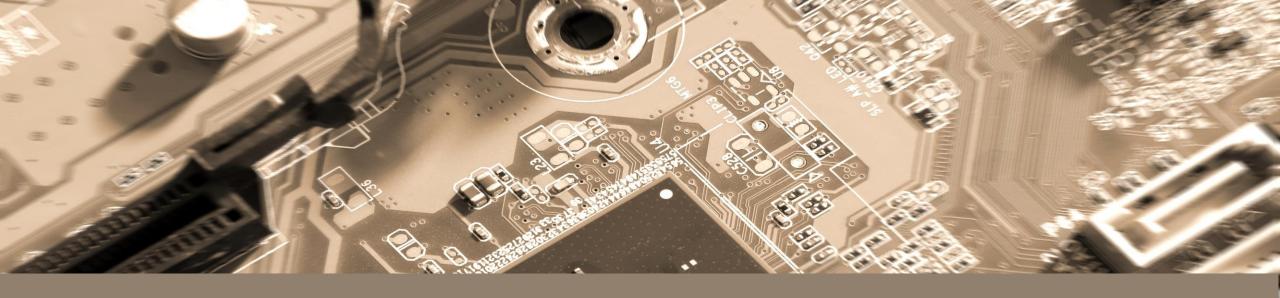


## REFERENCE MATERIALS



- IPC-A-610H, Acceptability of Electronic Assemblies
- IPC-AJ-820 Assembly and Joining Handbook
- IPC-T-50 Terms and Definitions for Interconnecting and Packaging Electronic Circuits





# End of Introduction

